

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6652604

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YAN-RUNG LIN	03/31/2021
CHIH-HSIANG LIU	04/01/2021
CHUNG-LUN KUO	03/31/2021
HSIANG-CHUN WEI	03/31/2021
YEOU-SUNG LIN	03/31/2021
CHIEH-YI LO	03/31/2021
RECEIVING PARTY DATA	
Name:	INDUSTRIAL TECHNOLOGY RESEARCH INSTITUTE
Street Address:	195, SEC. 4, CHUNG HSING RD., CHUTUNG,
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	310401
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17135874
CORRESPONDENCE DATA	
Fax Number:	(949)391-4699
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	USA@JCIPGROUP.COM
Correspondent Name:	JCIPRNET
Address Line 1:	8F-1, NO. 100, ROOSEVELT RD. SEC. 2,
Address Line 4:	TAIPEI, TAIWAN 100404
ATTORNEY DOCKET NUMBER:	098606-US-PA
NAME OF SUBMITTER:	BELINDA LEE
SIGNATURE:	/Belinda Lee/
DATE SIGNED:	04/13/2021
Total Attachments: 2	
source=098606US_Assgn#page1.tif	

ASSIGNMENT

WHEREAS,

1. Yan-Rung Lin
3. Chung-Lun Kuo
5. Yeou-Sung Lin

2. Chih-Hsiang Liu
4. Hsiang-Chun Wei
6. Chieh-Yi Lo

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **INSPECTION APPARATUS AND INSPECTION METHOD FOR INSPECTING LIGHT-EMITTING DIODES**

[] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, 1. Industrial Technology Research Institute
of 195, Sec. 4, Chung Hsing Rd., Chutung, Hsinchu 310401,
Taiwan, R. O. C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Yan-Rung Lin Date: 2021/03/31
Sole or First Joint Inventor: Yan-Rung Lin

Signature: Chih-Hsiang Liu Date: 2021/04/01
Second Joint Inventor (if any): Chih-Hsiang Liu

Signature: Chung-Lun Kuo Date: 2021/03/31
Third Joint Inventor (if any): Chung-Lun Kuo

Signature: Hsiang-Chun Wei Date: 2021/03/31
Fourth Joint Inventor (if any): Hsiang-Chun Wei

Signature: Yeou-Sung Lin Date: 2021/03/31
Fifth Joint Inventor (if any): Yeou-Sung Lin

Signature: Chieh-Yi Lo Date: 2021/03/31
Sixth Joint Inventor (if any): Chieh-Yi Lo